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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masaru Inoue	06/08/2009
Kunihiko Sasaki	06/08/2009
Takashi Kurihara	06/05/2009
Yasuhiro Kume	05/27/2009

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Name:	TOYO Corporation
Street Address:	1-6, Yaesu 1-chome, Chuo-ku
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State/Country:	JAPAN
Postal Code:	103-8284

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Street Address:	22-22, Nagaike-cho, Abeno-ku
City:	Osaka-shi
State/Country:	JAPAN
Postal Code:	545-8522

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13489198

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PATENT

REEL: 028361 FRAME: 0516

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Total Attachments: 4
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In consideration of value received, I, having a residence as stated below above my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

PHYSICAL PROPERTY MEASURING METHOD FOR TFT LIQUID CRYSTAL PANEL AND PHYSICAL PROPERTY MEASURING APPARATUS FOR TFT LIQUID CRYSTAL PANEL

have sold and assigned and do hereby sell and assign to

- 1. TOYO Corporation, a Japanese corporation, having a business address at 1-6, Yaesu 1-chome, Chuo-ku, Tokyo 103-8284 Japan; and
- 2. Sharp Kabushiki Kaisha, a Japanese corporation, having a business address at 22-22, Nagaike-cho, Abeno-ku, Osaka-shi, Osaka 545-8522, Japan

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said United States patent application:

(check one)	[X]	executed concurrently herewith		
	[]	executed on	;	
	[]	Application No.	, filed	

and in and to all applications for patent and patents for invention including all divisions, reissues, continuations, substitutes and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, continued prosecution, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention.

I hereby grant the following law firm the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Baker & Hostetler LLP, Washington Square, Suite 1100, 1050 Connecticut Avenue, N.W., Washington, D.C. 20036·5304

[1st Inventor] Residence Address: Tokyo, Japan Mailing Address: c/o TOYO Corporation, 1-6, Yaesu Citizenship: Japan	1-chome, Chuo-ku, Tokyo 103-8284, Japan
Masaru Inoue	Date:
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Yasuhiro Kume Janhuro Zume.	May 27, 2009

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its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said United States patent application:

(check one)	[X]	executed concurrently herewith		
		executed on Application No.	; , filed	
			,	

and in and to all applications for patent and patents for invention including all divisions, reissues, continuations, substitutes and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, continued prosecution, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention.

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Yasuhiro Kume	Date:

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